502627208 01/09/2014

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2673817

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MANG-MANG LING	11/05/2013
JUNGMIN KO	11/04/2013
SEAN S. KANG	11/04/2013
JEREMIAH T. PENDER	11/08/2013
SRINIVAS D. NEMANI	11/01/2013
BRADLEY HOWARD	11/04/2013

RECEIVING PARTY DATA

Name:	APPLIED MATERIALS, INC.	
Street Address:	3050 BOWERS AVENUE	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95054	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14059416

CORRESPONDENCE DATA

Fax Number: (713)623-4846 **Phone**: 7136234844

Email: jekin@pattersonsheridan.com, psdocketing@pattersonsheridan.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: PATTERSON & SHERIDAN, LLP
Address Line 1: 3040 POST OAK BOULEVARD

Address Line 2: SUITE 1500

Address Line 4: HOUSTON, TEXAS 77056

ATTORNEY DOCKET NUMBER:	APPM/21082US/ETCH/CHMBR
	PATENT

502627208 REEL: 031926 FRAME: 0276

NAME OF SUBMITTER: KEITH TABOADA	
Signature:	/Keith Taboada/
Date:	01/09/2014
Total Attachments: 8 source=021082_USL_ASG_2014-01-09#pa source=021082_USL_ASG_2014-01-09#pa source=021082_USL_ASG_2014-01-09#pa source=021082_USL_ASG_2014-01-09#pa source=021082_USL_ASG_2014-01-09#pa source=021082_USL_ASG_2014-01-09#pa source=021082_USL_ASG_2014-01-09#pa source=021082_USL_ASG_2014-01-09#pa source=021082_USL_ASG_2014-01-09#pa	ge2.tif ge3.tif ge4.tif ge5.tif ge5.tif ge6.tif

PATENT REEL: 031926 FRAME: 0277 Assignment Page 1 of 2

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MANG-MANG LING	11/05/2013
JUNGMIN KO	11/04/2013
SEAN S. KANG	11/04/2013
JEREMIAH T. PENDER	11/08/2013
SRINIVAS D. NEMANI	11/01/2013
BRADLEY HOWARD	11/04/2013

RECEIVING PARTY DATA

Name:	APPLIED MATERIALS, INC.	
Street Address:	3050 BOWERS AVENUE	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95054	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	61868037

CORRESPONDENCE DATA

Fax Number: (713)623-4846 **Phone:** 7136234844

Email: jekin@pattersonsheridan.com, psdocketing@pattersonsheridan.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: PATTERSON & SHERIDAN, LLP

Address Line 1: 3040 POST OAK BOULEVARD

Address Line 2: SUITE 1500

Address Line 4: HOUSTON, TEXAS 77056

PATENT FFI · 031926 FRAMF· 0278 Assignment Page 2 of 2

KEITH TABOADA
/Keith Taboada/
01/09/2014

Total Attachments: 4

source=APPM_21082USL_ASG#page1.tif source=APPM_21082USL_ASG#page2.tif source=APPM_21082USL_ASG#page3.tif source=APPM_21082USL_ASG#page4.tif

RECEIPT INFORMATION

EPAS ID: PAT2673583 **Receipt Date**: 01/09/2014

USPTO. EPAS. Receipt Page 1 of 2



United States Patent and Trademark Office



Home | Site Index | Search | Guides | Contacts | eBusiness | eBiz alerts | News | Help

Electronic Patent Assignment System

Confirmation Receipt

Your assignment has been received by the USPTO. The coversheet of the assignment is displayed below:

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1

Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MANG-MANG LING	11/05/2013
JUNGMIN KO	11/04/2013
SEAN S. KANG	11/04/2013
JEREMIAH T. PENDER	11/08/2013
SRINIVAS D. NEMANI	11/01/2013
BRADLEY HOWARD	11/04/2013

RECEIVING PARTY DATA

Name:	me: APPLIED MATERIALS, INC.	
Street Address:	reet Address: 3050 BOWERS AVENUE	
City:	SANTA CLARA	
State/Country: CALIFORNIA		
Postal Code: 95054		

PATENT REEL: 031926 FRAME: 028 $\rho_{9/2014}$ USPTO. EPAS. Receipt Page 2 of 2

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	61868037	

CORRESPONDENCE DATA

Fax Number: (713)623-4846 **Phone:** 7136234844

 $\textbf{Email:} \hspace*{1.5cm} \textbf{jekin@pattersonsheridan.com, psdocketing@pattersonsheridan.com}$

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: PATTERSON & SHERIDAN, LLP

Address Line 1: 3040 POST OAK BOULEVARD Address Line 2: SUITE 1500

Address Line 4: HOUSTON, TEXAS 77056

ATTORNEY DOCKET

NUMBER:

021082/ETCH/CHMBR/MDD

NAME OF SUBMITTER:

KEITH TABOADA

Signature:

/Keith Taboada/

Date:

01/09/2014

Total Attachments: 4

source=APPM_21082USL_ASG#page1.tif

source=APPM_21082USL_ASG#page2.tif

source=APPM_21082USL_ASG#page3.tif

source=APPM 21082USL ASG#page4.tif

RECEIPT INFORMATION

EPAS ID: PAT2673583 **Receipt Date:** 01/09/2014

Return to home page

| .HOME | INDEX| SEARCH | @BUSINESS | CONTACT US | PRIVACY STATEMENT

PATENT REEL: 031926 FRAME: 0281/19/2014

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Mang-Mang LING 1352 Millich Lane San Jose, California 95117	2)	Jungmin KO 2410 Woodland Avenue San Jose, CA, 95128
3)	Sean S. KANG 5132 Holborn Way San Ramon, California 94582	4)	Jeremiah T. PENDER 1565 Fuchsia Drive San Jose, California 95125
5)	Srinivas D. NEMANI 504 Fern Ridge Court Sunnyvale, California 94087	6)	Bradley HOWARD 1400 Oak Vista Way Pleasanton, California 94566

(hereinafter referred to as Assignors), have invented a certain invention entitled:

METHODS FOR FORMING FEATURES IN A MATERIAL LAYER UTILIZING A COMBINATION OF A MAIN ETCHING AND A CYCLICAL ETCHING PROCESS

for which application for Letters Patent in the United States was filed on August 20, 2013, under Serial No. 61/868,037, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, conventional, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority

1

proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	Nov5, 2013 (DATE)	many france 1:
		Mang-Mang LING
2)	(DATE)	Jungmin KO
3)	(DATE)	Sean S, KANG
4)	(DATE)	Landiak T DENIGED
5)	(DATE)	Jeremiah T. PENDER
,	And the state of t	Srinivas D. NEMANI
6)	(DATE)	Bradlay HOWARD

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Mang-Mang LING 1352 Millich Lane San Jose, California 95117	2)	Jungmin KO 2410 Woodland Avenue San Jose, CA, 95128
3)	Sean S. KANG 5132 Holborn Way San Ramon, California 94582	4)	Jeremiah T. PENDER 1565 Fuchsia Drive San Jose, California 95125
5)	Srinivas D. NEMANI 504 Fern Ridge Court Sunnyvale, California 94087	6)	Bradley HOWARD 1400 Oak Vista Way Pleasanton, California 94566

(hereinafter referred to as Assignors), have invented a certain invention entitled:

METHODS FOR FORMING FEATURES IN A MATERIAL LAYER UTILIZING A COMBINATION OF A MAIN ETCHING AND A CYCLICAL ETCHING PROCESS

for which application for Letters Patent in the United States was filed on August 20, 2013, under Serial No. 61/868,037, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and Interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, conventional, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority

1

proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	(DATE)	Mary Mary LIMO
2)	11/4/13 (DATE)	Mang-Mang LING Jungmin KO Jungmin KO
3)	11/4/13 (DATE)	Poor S. KANG
4)	11/8/13 (DATE)	Sean S. KANG Jeremiah T. PENDER
5)	11 / 1 /20 13 (DATE)	Srinivas D. NEMANI
6)	11/4/2013 (DATE)	Senaley 1 Woward Bradley HOWARD